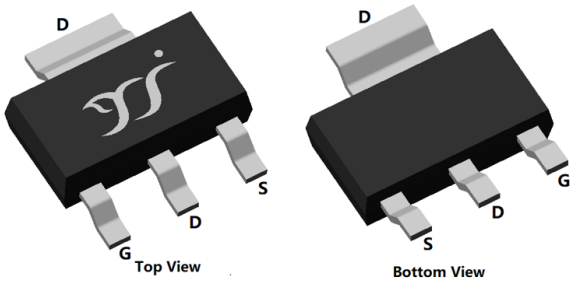
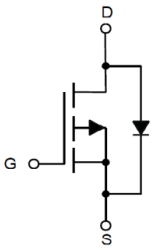
P-Channel Enhancement Mode Field Effect Transistor



SOT-223



Product Summary

- V_{DS} -60 V
- I_D -5 A
- $R_{DS(ON)}$(at V_{GS}=-10V) ＜55 mΩ
- $R_{DS(ON)}$(at V_{GS}=-4.5V) ＜70 mΩ

General Description

- Split gate trench MOSFET technology
- Extremely low switching loss
- Excellent stability and uniformity
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power management
- Load switch

■ Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	-60	V
Gate-source Voltage		V_{GS}	±20	V
Drain Current	T_A=25℃	I_D	-5	A
	T_A=100℃		-3	
Pulsed Drain Current [A]		I_{DM}	-25	A
Total Power Dissipation [B]	T_A=25℃	P_D	1	W
	T_A=100℃		0.4	
Junction and Storage Temperature Range		T_J ,T_{STG}	-55～+150	℃

■Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient [C]	Steady-State	$R_{\theta JA}$	100	120	℃/W

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJM05GP06A	F2	05GP06	2500	5000	25000	13“ reel

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-60V, V_{GS}=0V	-	-	-1	μA
		V_{DS}=-60V, V_{GS}=0V, Tj=150℃	-	-	-100	
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±20V, V_{DS}=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=-250μA	-1.5	-2	-3	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=-10V, I_D=-5A	-	40	55	mΩ
		V_{GS}=-4.5V, I_D=-4A	-	50	70	
Diode Forward Voltage	V_{SD}	I_S=-5A, V_{GS}=0V	-	-0.9	-1.2	V
Gate resistance	R_G	f=1MHz, Open drain	-	12	-	Ω
Maximum Body-Diode Continuous Current	I_S		-	-	-5	A
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=-30V, V_{GS}=0V, f=1MHz	-	1050	-	pF
Output Capacitance	C_{oss}		-	380	-	
Reverse Transfer Capacitance	C_{rss}		-	20	-	
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=-10V, V_{DS}=-30V, I_D=-5A	-	18.7	-	nC
Gate-Source Charge	Q_{gs}		-	4.7	-	
Gate-Drain Charge	Q_{gd}		-	3	-	
Reverse Recovery Charge	Q_{rr}	I_F=-5A, di/dt=100A/us	-	8	-	nC
Reverse Recovery Time	t_{rr}		-	20	-	ns
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=-10V, V_{DD}=-30V, ID=-5A RGEN=2.2Ω	-	7.5	-	ns
Turn-on Rise Time	t_r		-	40	-	
Turn-off Delay Time	$t_{D(off)}$		-	43	-	
Turn-off fall Time	t_f		-	55	-	

A. Repetitive rating; pulse width limited by max. junction temperature.
B. P_d is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.
C. The value of RθJA is measured with the device mounted on the minimum recommend pad size, in the still air environment with TA =25℃. The maximum allowed junction temperature of 150℃. The value in any given application depends on the user's specific board design.

■Typical Electrical and Thermal Characteristics Diagrams

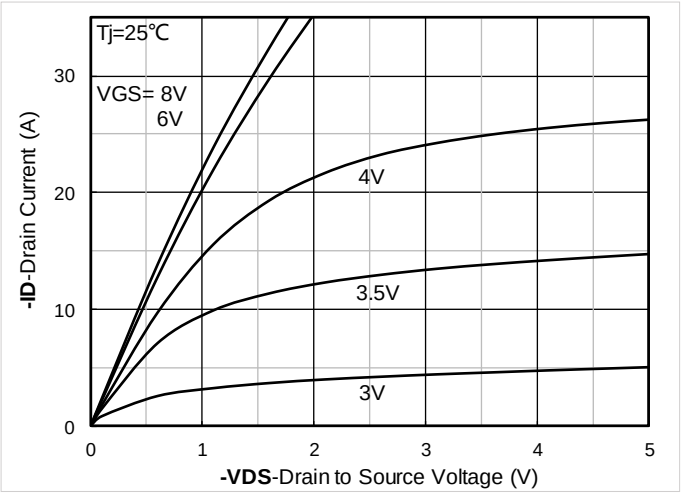


Figure 1. Output Characteristics

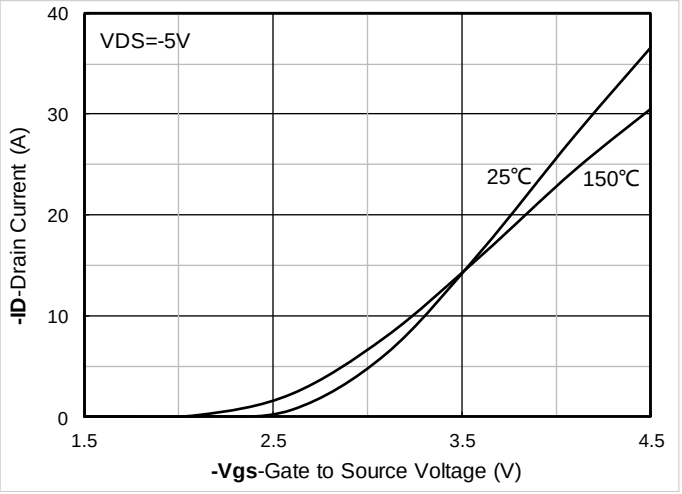


Figure 2. Transfer Characteristics

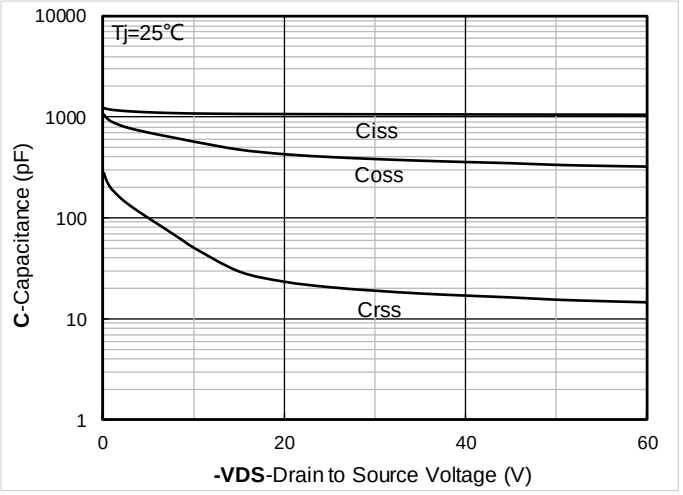


Figure 3. Capacitance Characteristics

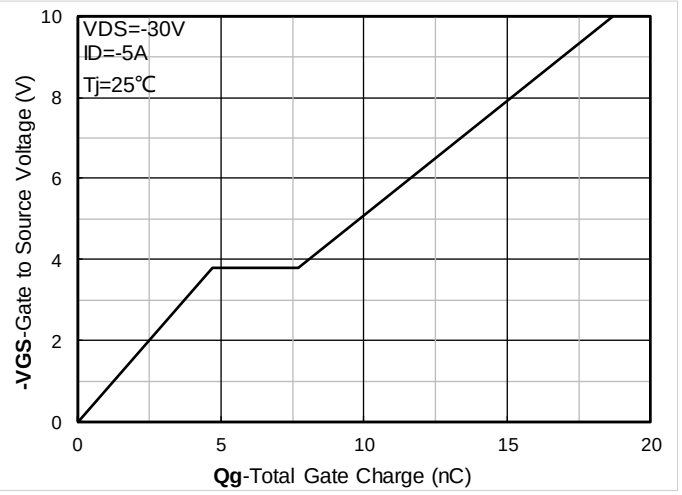


Figure 4. Gate Charge

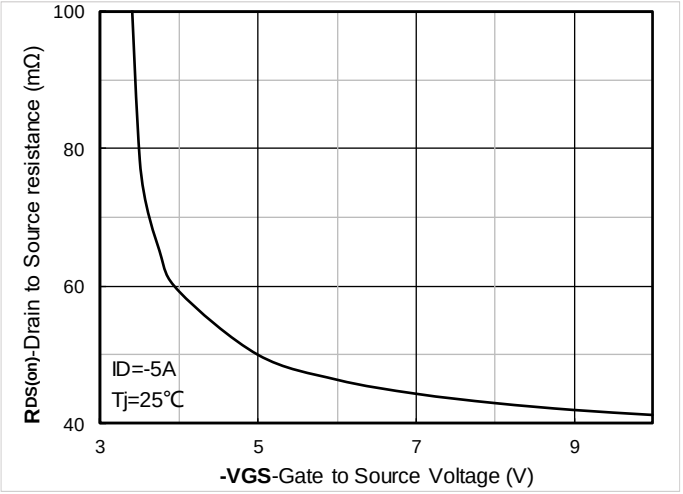


Figure 5. On-Resistance vs Gate to Source Voltage

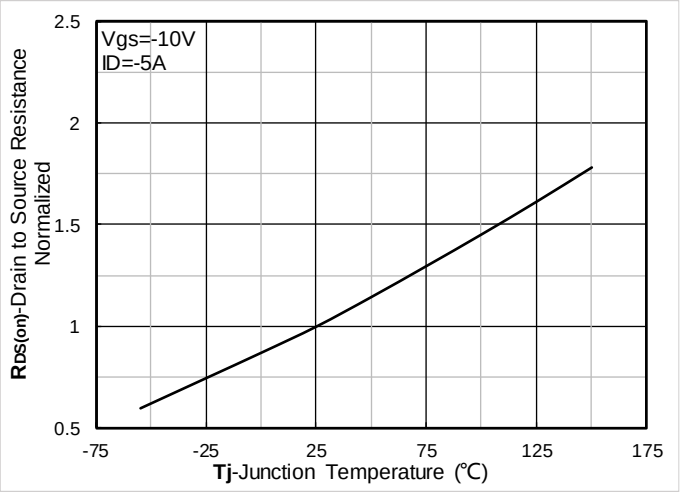


Figure 6. Normalized On-Resistance

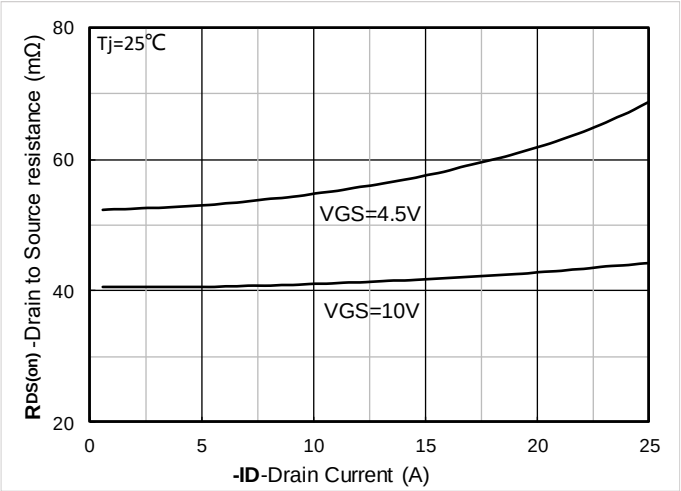


Figure 7. RDS(on) VS Drain Current

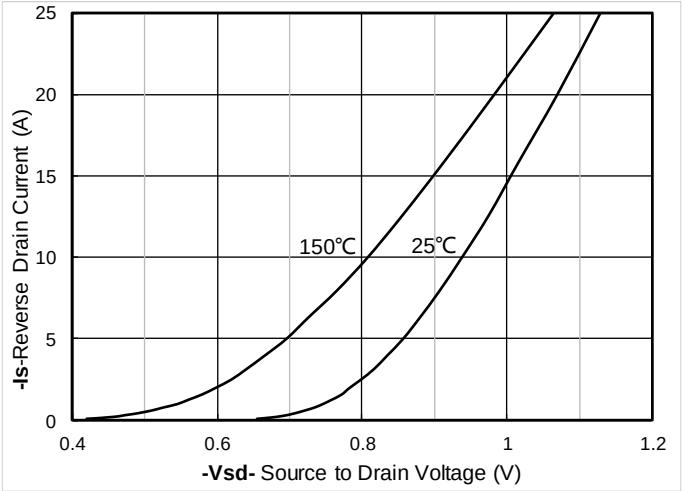


Figure 8. Forward characteristics of reverse diode

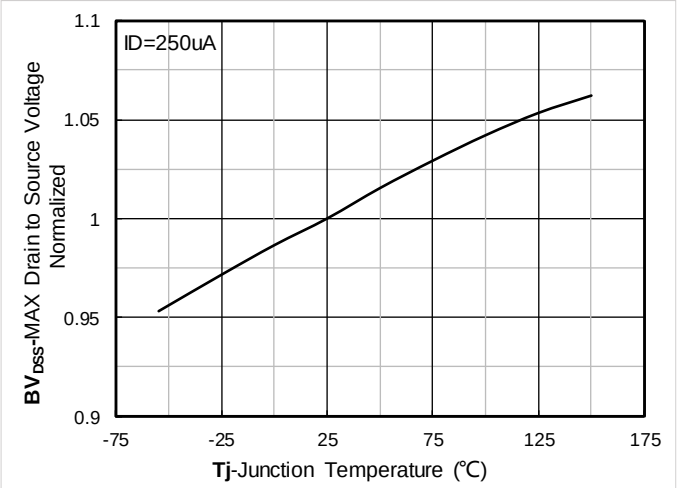


Figure 9. Normalized breakdown voltage

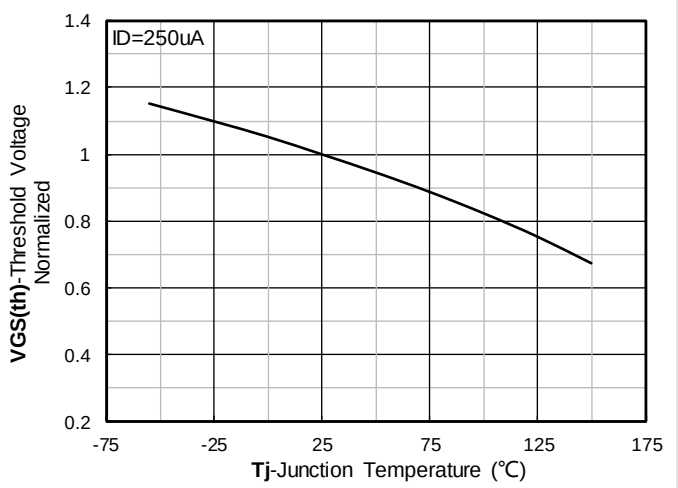


Figure 10. Normalized Threshold voltage

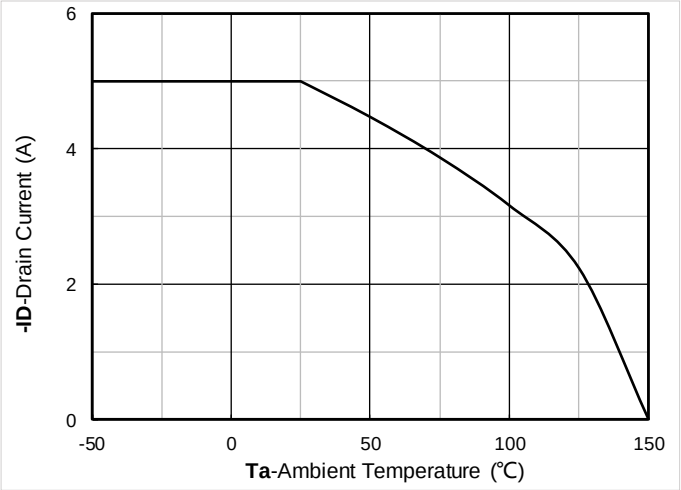


Figure 11. Current dissipation

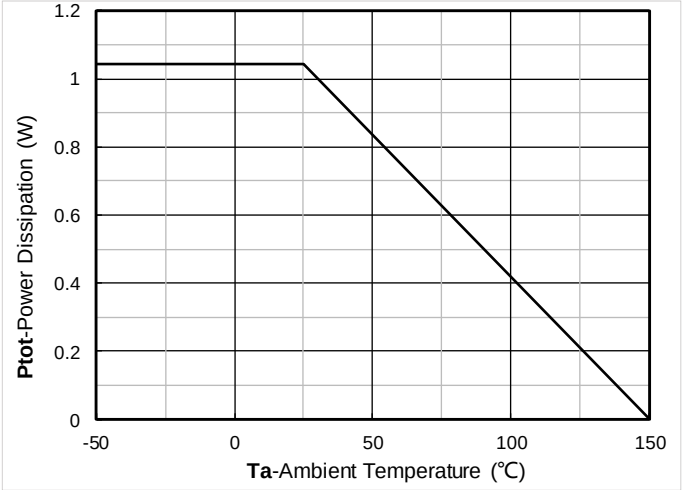


Figure 12. Power dissipation

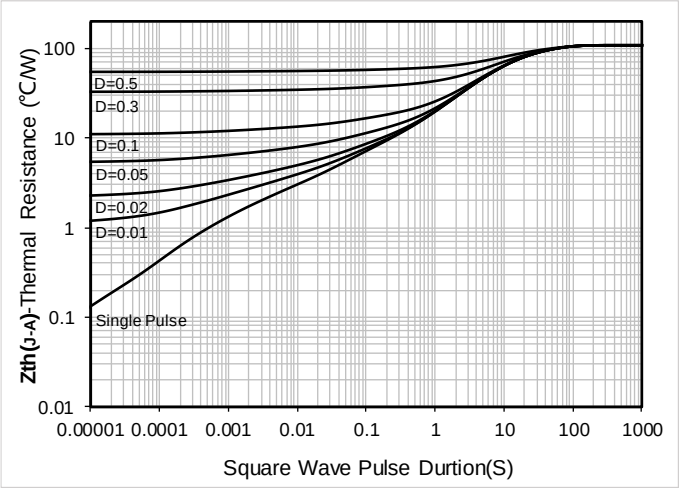


Figure 13. Maximum Transient Thermal Impedance

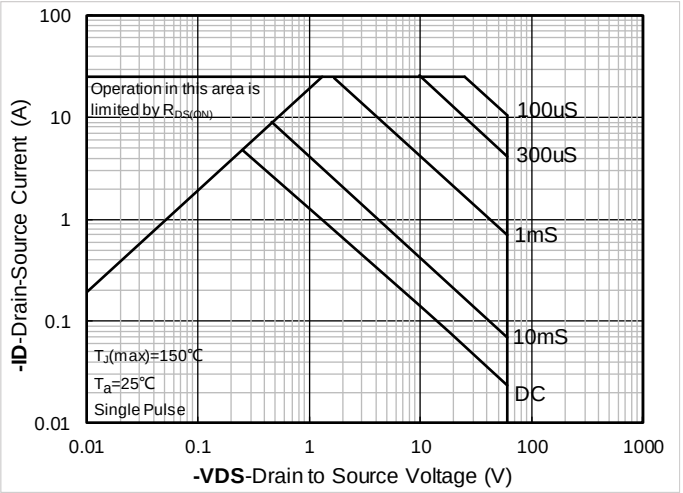
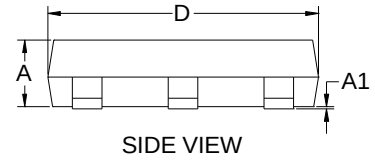
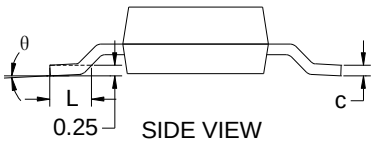


Figure 14. Safe Operation Area

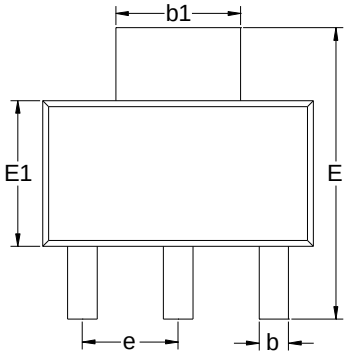
■ SOT-223 Package Information



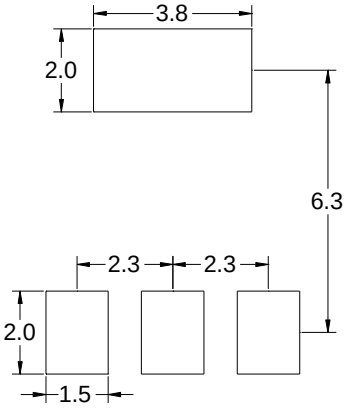
SIDE VIEW



SIDE VIEW



TOP VIEW



SUGGESTED SOLDER PAD LAYOUT

DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MN	MAX
A	0.0591	0.0670	1.5000	1.7000
A1	0.0008	0.0039	0.0200	0.1000
b	0.0259	0.0330	0.6600	0.8400
b1	0.1140	0.1220	2.9000	3.1000
c	0.0090	0.0138	0.2300	0.3500
D	0.2480	0.2640	6.3000	6.7000
E	0.2637	0.2874	6.7000	7.3000
E1	0.1290	0.1460	3.3000	3.7000
e	0.0866	0.0945	2.2000	2.4000
L	0.0295	0.0492	0.7500	1.2500
θ	0°	10°	0°	10°

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